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RULE				
APPLICANTS Kenshi Fukumitsu, Shizuoka, JAPAN; Fumitsugu Fukuyo, Shizuoka, JAPAN; Naoki Uchiyama, Shizuoka, JAPAN; Ryuji Sugiura, Shizuoka, JAPAN; Kazuhiro Atsumi, Shizuoka, JAPAN;				
** CONTINUING DATA ***** This application is a 371 of PCT/JP04/13163 09/09/2004				
** FOREIGN APPLICATIONS ***** JAPAN 2003-318875 09/10/2003 JAPAN 2004-213499 07/21/2004				
** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 01/05/2007				
Foreign Priority claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No 35 USC 119(a-d) conditions met <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No Verified and Acknowledged <u>/DANIEL B WHALEN/</u> Examiner's Signature	<input type="checkbox"/> Met after Allowance Initials	STATE OR COUNTRY JAPAN	SHEETS DRAWINGS 23	TOTAL CLAIMS 3
INDEPENDENT CLAIMS 1				
ADDRESS DRINKER BIDDLE & REATH (DC) 1500 K STREET, N.W. SUITE 1100 WASHINGTON, DC 20005-1209 UNITED STATES				
TITLE Semiconductor substrate cutting method				
FILING FEE RECEIVED 1030	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	